

CALL FOR PAPERS

IEEE, the world's largest technical professional organization dedicated to advancing technology for humanity, and the IEEE Ultrasonics, Ferroelectrics, and Frequency Control Society (UFFC-S) today announced a call for papers for Latin America Ultrasonics Symposium being held virtually on October 4th and 5th.

The first IEEE Latin America Ultrasonics Symposium aims to reinforce existing networking opportunities and to promote emerging networking opportunities to the ultrasonics engineering community in Latin America in connection with other parts of the world. Abstract should be submitted according to the guidelines available on the conference website. The accepted abstracts describing novel research will be eligible to submit a full paper to be published by IEEE Xplore. Original papers in the field of ultrasonics are solicited from the following list of topics:

- » Biomedical ultrasonics
- » Clinical ultrasound
- » Nondestructive evaluation
- » Industrial applications
- » Transducers, sensors, and actuators
- » Physical Acoustics
- » Acoustofluidics

Abstracts reviewing the scientific activities of research groups within Latin America are also welcome.

The Symposium program will include plenary sessions, peer-reviewed paper sessions, and exciting networking activities. A full oral session will be dedicated to a student paper competition.

About the Latin America Outreach Initiative

The UFFC-S seeks to provide services and opportunities to people in the fields that the society operates in and increase its diversity and the support for the Latin American community. This initiative is in line with multiple other activities and resources from IEEE UFFC-S, where opportunities are available to connect senior and earlier career members worldwide within a network that genuinely represents the UFFC-S goals and interests.

About IEEE

IEEE is the world's largest technical professional organization dedicated to advancing technology for the benefit of humanity. Through its highly cited publications, conferences, technology standards, and professional and educational activities, IEEE is the trusted voice on a wide variety of areas ranging from aerospace systems, computers, and telecommunications to biomedical engineering, electric power, and consumer electronics. Learn more at www.ieee.org.

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Discounted Low-to-Middle-Income Registration Fees*

Registration fees by August 30th:

Students, IEEE affiliated	US\$10
Students, non-IEEE affiliated <i>(IEEE and UFFC-S memberships are included in the registration package)</i>	US\$20
Professionals, IEEE affiliated	US\$25
Professionals, non-IEEE affiliated <i>(UFFC-S affiliation is included in the registration package)</i>	US\$50

Registration fees after August 30th:

Students, IEEE affiliated	US\$15
Students, non-IEEE affiliated <i>(IEEE and UFFC-S memberships are not included in the registration package)</i>	US\$30
Professionals, IEEE affiliated	US\$35
Professionals, non-IEEE affiliated <i>(UFFC-S affiliation is not included in the registration package)</i>	US\$70

*LAUS 2021 is offering discounted registration rates for people who currently reside in developing nations where the per capita Gross National Income (GNI) is US\$15,000 or less, as determined by the data published by the World Bank. Please visit the conference website for more information on registration and to help you determine if you qualify for the LMIC discounted registration fees.

Important Dates

July 2, 2021

Initial Abstract
Submission Deadline

August 6, 2021

Notification to
Authors

October 11, 2021

Final Submission
Deadline



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